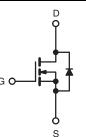
Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	100				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.54				
Q _g (Max.) (nC)	8.3				
Q _{gs} (nC)	2.3				
Q _{gd} (nC)	3.8				
Configuration	Single)			





N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR110, SiHFR110)
- Available in Tape and Reel
- Fast Switching
- Ease of Paralleling
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)		
Lead (Pb)-free and Halogen-free	SiHFR110-GE3	SiHFR110TRL-GE3	SiHFR110TR-GE3	SiHFR110TRR-GE3		
Lead (Pb)-free	IRFR110PbF	IRFR110TRLPbFa	IRFR110TRPbF ^a	IRFR110TRRPbF ^a		
Lead (PD)-free	SiHFR110-E3	SiHFR110TL-E3 ^a	SiHFR110T-E3 ^a	SiHFR110TR-E3 ^a		

Note

a. See device orientation.

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	100	N		
Gate-Source Voltage		V _{GS}	± 20	- V	
Continuous Drain Current	1-	4.3			
Continuous Drain Current	I _D	2.7	А		
Pulsed Drain Current ^a	I _{DM}	17			
Linear Derating Factor		0.20	W/°C		
Linear Derating Factor (PCB Mount) ^e		0.020	W/°C		
Single Pulse Avalanche Energy ^b		E _{AS}	75	mJ	
Repetitive Avalanche Current ^a			I _{AR}	4.3	Α
Repetitive Avalanche Energy ^a			E _{AR}	2.5	mJ
Maximum Power Dissipation	25 °C	р	25	w	
Maximum Power Dissipation (PCB Mount) ^e	P _D	2.5	vv		
Peak Diode Recovery dV/dt ^c	dV/dt	5.5	V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) ^d					

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 8.1 mH, R_g = 25 Ω , I_{AS} = 4.3 A (see fig. 12).

c. $I_{SD} \le 5.6$ A, $dI/dt \le 75$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

Availab



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	110		
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	50	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	5.0		

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C, I _D = 1 mA	-	0.13	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zara Cata Valtaga Drain Current		V _{DS} =	= 100 V, V _{GS} = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 2.6 A ^b	-	-	0.54	Ω
Forward Transconductance	9 _{fs}	V _{DS} :	= 50 V, I _D = 2.6 A	1.6	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		-	180	-	pF
Output Capacitance	C _{oss}			-	80	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	15	-	
Total Gate Charge	Qg			-	-	8.3	
Gate-Source Charge	Q_gs	$V_{GS} = 10 V$	I _D = 5.6 A, V _{DS} = 80 V, see fig. 6 and 13 ^b	-	-	2.3	nC
Gate-Drain Charge	Q_gd			-	-	3.8	
Turn-On Delay Time	t _{d(on)}			-	6.9	-	
Rise Time	t _r	V _{DD} =	= 50 V, I _D = 5.6 A,	-	16	-	ns
Turn-Off Delay Time	t _{d(off)}	$R_g = 24 \Omega,$	$R_D = 8.4 \Omega$, see fig. 10^{b}	-	15	-	115
Fall Time	t _f			-	9.4	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25")	from	-	4.5	-	nH
Internal Source Inductance	L _S	 package and die contact 		-	7.5	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the		-	-	4.3	Α
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	17	~
Body Diode Voltage	V_{SD}	T _J = 25 °C	, $I_{\rm S}$ = 4.3 A, $V_{\rm GS}$ = 0 V ^b	-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 °C I	= 5.6 A, dl/dt = 100 A/µs ^b	-	100	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$J = 25 \text{ C}, I_{\text{F}}$	$= 5.0 \text{ A}, \text{ u/ul} = 100 \text{ A/}\mu\text{S}^{0}$	-	0.44	0.88	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %.





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

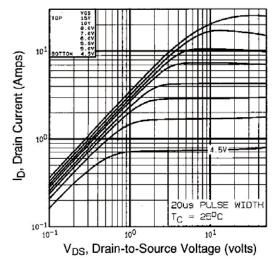


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

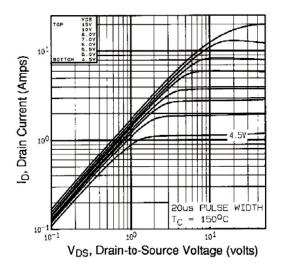


Fig. 2 -Typical Output Characteristics, T_C = 150 °C

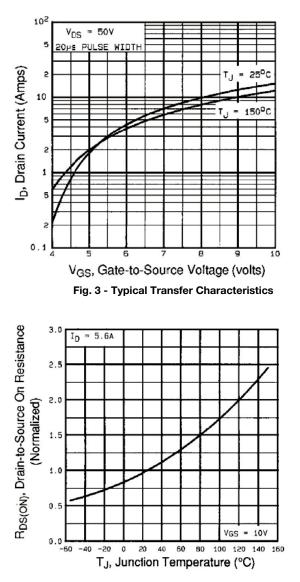


Fig. 4 - Normalized On-Resistance vs. Temperature

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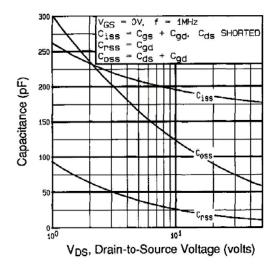
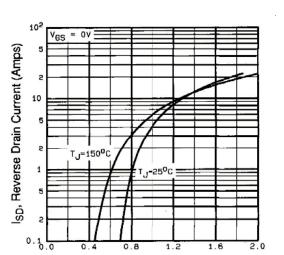


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



V_{SD}, Source-to-Drain Voltage (volts)



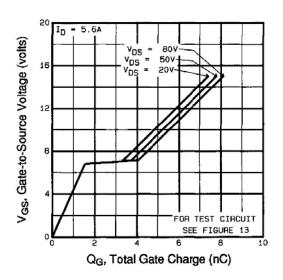


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

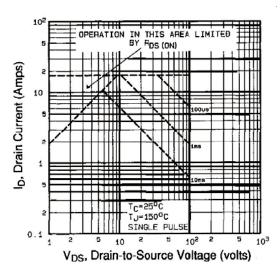


Fig. 8 - Maximum Safe Operating Area

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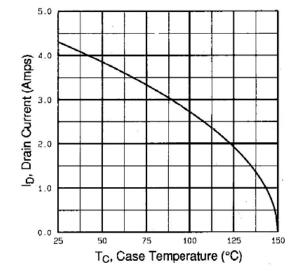


Fig. 9 - Maximum Drain Current vs. Case Temperature

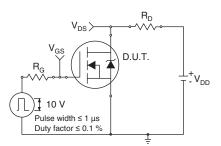


Fig. 10a - Switching Time Test Circuit

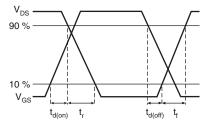


Fig. 10b - Switching Time Waveforms

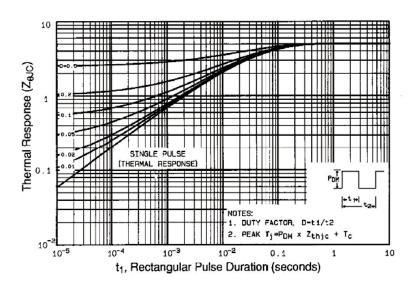


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

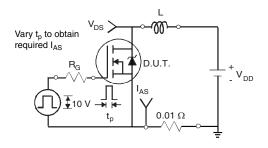
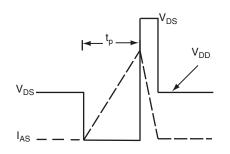
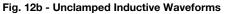


Fig. 12a - Unclamped Inductive Test Circuit





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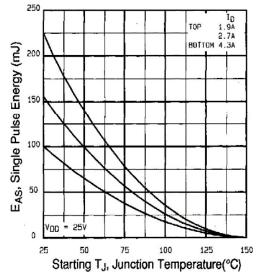


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

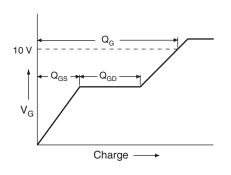


Fig. 13a - Basic Gate Charge Waveform

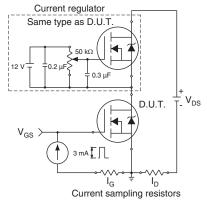
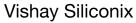
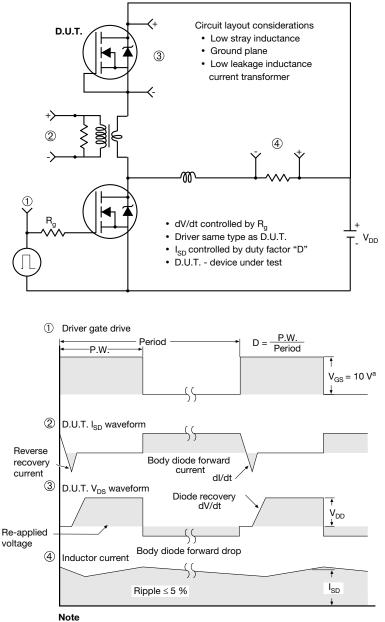


Fig. 13b - Gate Charge Test Circuit





Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







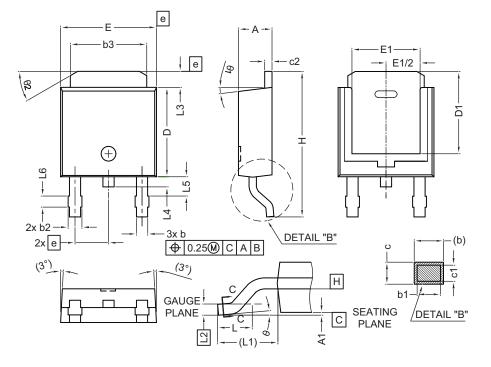
	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	BSC		
e1	4.56	BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIN	METERS
DIM.	MIN.	MAX.
A	2.18	2.39
A1	-	0.13
b	0.65	0.89
b1	0.64	0.79
b2	0.76	1.13
b3	4.95	5.46
С	0.46	0.61
c1	0.41	0.56
c2	0.46	0.60
D	5.97	6.22
D1	5.21	-
E	6.35	6.73
E1	4.32	-
е	2.29	BSC
Н	9.94	10.34

	MILLIMETERS			
DIM.	MIN.	MAX.		
L	1.50	1.78		
L1	2.74	l ref.		
L2	0.51	BSC		
L3	0.89	1.27		
L4	-	1.02		
L5	1.14	1.49		
L6	0.65	0.85		
θ	0°	10°		
θ1	0°	15°		
θ2	25°	35°		

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347



TO-251AA (HIGH VOLTAGE)



	MILLI	METERS	INC	HES		MILLI	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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Vishay

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